

HA1631S01/02/03/04 Series

Single CMOS Comparator (Push Pull/Open Drain Output)

REJ03D0056-0100Z

Rev.1.00

2003.08.08

Description

The HA1631S01/02/03/04 are low power single CMOS Comparator featuring low voltage operation with typical current supply of 5 μ A/50 μ A. They are designed to operate from a single power supply. HA1631S01/02 have push-pull full swing outputs that allow direct connections to logic devices. The Open Drain version HA1631S03/04 enable Output Level shifting through external pull up resistors. Available in an ultra-small CMPAK-5 package, they occupy only 1/8 the area of the SOP-8 package.

Features

- Low supply current
HA1631S01/03: $I_{DDtyp} = 5 \mu A$ ($V_{DD} = 3.0 V$)
HA1631S02/04: $I_{DDtyp} = 50 \mu A$ ($V_{DD} = 3.0 V$)
- Low voltage operation: $V_{DD} = 1.8$ to $5.5 V$
- Low input offset voltage: $V_{IOmax} = 5 mV$
- Low input bias current: $I_{IBtyp} = 1 pA$
- Maximum output voltage: $V_{OHmin} = 2.9 V$ (at $V_{DD} = 3.0 V$)
- Input common voltage range includes ground
- On-chip ESD protection
- Available in CMPAK-5 and MPAK-5 package using Pb free lead frame

Outline



CMPAK-5V

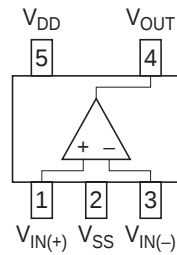
HA1631S01CM
HA1631S02CM
HA1631S03CM
HA1631S04CM



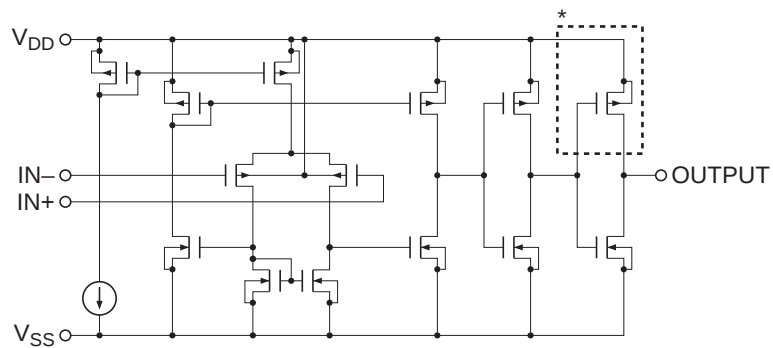
MPAK-5V

HA1631S01LP
HA1631S02LP
HA1631S03LP
HA1631S04LP

Pin Arrangement



Equivalent Circuit



* Not available in Open Drain version (HA1631S03/04)

Absolute Maximum Ratings

(Ta = 25°C)

Item	Symbol	Ratings	Unit	Remarks
Supply voltage	V _{DD}	7.0	V	
Differential input voltage	V _{IN(diff)}	−V _{DD} to +V _{DD}	V	Note 1
Input voltage	V _{IN}	0.1 to +V _{DD}	V	
Output current	I _{OUT}	28	mA	Note 2
Power dissipation	P _T	80/120	mW	CMPAK/MPAK
Operating temperature	T _{opr}	−40 to +85	°C	
Storage temperature	T _{stg}	−55 to +125	°C	

Notes: 1. Do not apply input voltage exceeding V_{DD} or 7 V.

2. The maximum output current is the maximum allowable value for continuous operation.

Electrical Characteristics

(Ta = 25°C, V_{DD} = 3.0 V, V_{SS} = 0 V)

Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Input offset voltage	V _{IO}	—	—	5	mV	V _{IN} = V _{DD} /2, R _L = 1MΩ
Input bias current	I _{IB}	—	(1)	100	pA	V _{IN} = V _{DD} /2
Input offset current	I _{IO}	—	(1)	100	pA	V _{IN} = V _{DD} /2
Common mode input voltage range	V _{CM}	−0.1	—	2.1	V	
Supply current	HA1631S01/03	I _{DD}	—	5	10	V _{DD} = 3V, V _{IN+} = 1V, V _{IN−} = 0V
	HA1631S02/04		—	50	100	
Response time	HA1631S01	TP _{LH}	—	(1.20)	—	1V DC bias, 100mV overdrive, C _L = 15pF
	HA1631S01/03	TP _{HL}	—	(0.55)	—	
	HA1631S01	t _r	—	(24)	—	
	HA1631S01/03	t _f	—	(7)	—	
	HA1631S02	TP _{LH}	—	(0.33)	—	
	HA1631S02/04	TP _{HL}	—	(0.17)	—	
	HA1631S02	t _r	—	(12)	—	
	HA1631S02/04	t _f	—	(7)	—	
Output source current (HA1631S01/02)	I _{OSOURCE}	6	13	—	mA	V _{out} = 2.5V
Output sink current	I _{OSINK}	7	14	—	mA	V _{out} = 0.5V
Common mode rejection ratio	HA1631S01/03	CMRR	60	80	—	V _{IN1} = 0V, V _{IN2} = 2V
	HA1631S02/04		50	70	—	
Power supply rejection ratio	PSRR	60	80	—	dB	V _{DD1} = 1.8V, V _{DD2} = 5.5V
Output voltage high	V _{OH}	V _{DD} −0.1	—	—	V	R _L = 10kΩ to V _{SS}
Output voltage low	V _{OL}	—	—	0.1	V	R _L = 10kΩ to V _{DD}
Output leakage current (Only for HA1631S03/04)	I _{LO}	—	(0.1)	—	nA	V _{IN+} = 1V, V _{IN−} = 0V, V _O = 3V
Operating voltage range	V _{opr}	1.8	—	5.5	V	

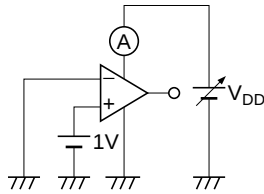
Note: (): Design specification

Table of Graphs

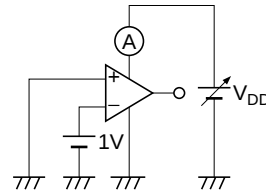
Electrical Characteristics			HA1631S01 Figure	HA1631S02 Figure	HA1631S03 Figure	HA1631S04 Figure	Test Circuit No.
Supply current	I_{DD}	vs. Supply voltage(Out H)	1-1	2-1	3-1	4-1	1
		vs. Supply voltage(Out L)	1-2	2-2	3-2	4-2	2
		vs. Temperature(Out H)	1-3	2-3	3-3	4-3	1
Output high voltage	V_{OH}	vs. Rload	1-18	2-18	3-4	4-4	4
Output source current	$I_{OSOURCE}$	vs. Output high voltage	1-4	2-4	—	—	5
Output low voltage	V_{OL}	vs. Rload	1-17	2-17	3-14	4-14	6
Output sink current	I_{OSINK}	vs. Output low voltage	1-5	2-5	3-4	4-4	5
Input offset voltage	V_{IO}	vs. Supply voltage	1-6	2-6	3-5	4-5	8
		vs. Temperature	1-7	2-7	3-6	4-6	7
Common mode input voltage range	V_{CM}	vs. Temperature	1-8	2-8	3-7	4-7	9
Power supply rejection ratio	PSRR	vs. Supply voltage	1-9	2-9	3-8	4-8	11
Common mode rejection ratio	CMRR	vs. Input voltage	1-10	2-10	3-9	4-9	12
Input bias current	I_{IB}	vs. Temperature	1-11	2-11	3-10	4-10	10
		vs. Input voltage	1-12	2-12	3-11	4-11	10
Falling time	t_f	vs. Temperature	1-13	2-13	3-12	4-12	13
		vs. Cload	1-15	2-15	3-13	4-13	13
		Time waveform	1-20	2-20	3-15	4-15	13
Rising time	t_r	vs. Temperature	1-14	2-14	—	—	13
		vs. Cload	1-16	2-16	—	—	13
		Time waveform	1-19	2-19	—	—	13
Propagation delay time	TP_{LH}	Time waveform	1-21	2-21	—	—	13
	TP_{HL}	Time waveform	1-22	2-22	3-16, 3-17	4-16, 4-17	13

Test Circuits

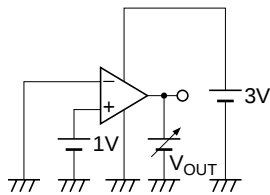
1. Supply Current, I_{DD} (Output High)



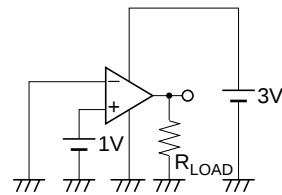
2. Supply Current, I_{DD} (Output Low)



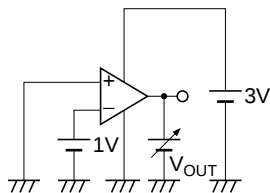
3. Output Source Current, $I_{OSOURCE}$



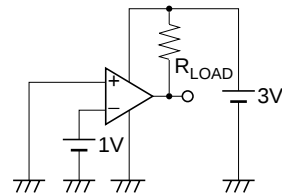
4. Output High Voltage, V_{OH} (Output High)



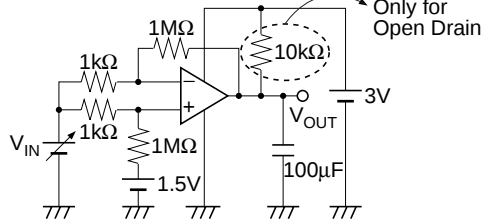
5. Output Sink Current, I_{OSINK}



6. Output Low Voltage, V_{OL} (Output Low)

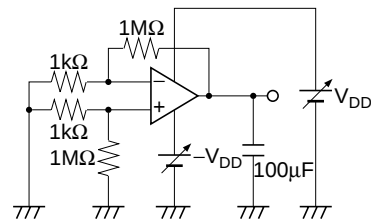


7. Input Offset Voltage, V_{IO}

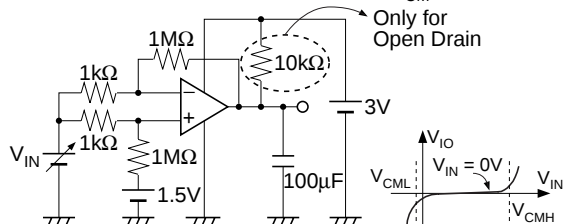


Note: $V_{IO} = V_{OUT} - 1.5V$

8. Input Offset Voltage vs. V_{DD}

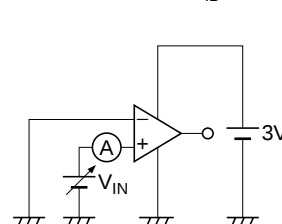


9. Common Mode Input Voltage Range, V_{CM}

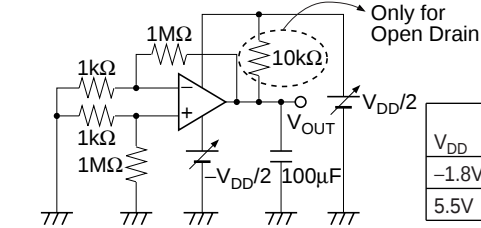


Note: V_{CML} and V_{CMH} are values of V_{IN} when V_{IO} changes more than 50dB taking $V_{IN} = 0V$ as reference.

10. Input Bias Current, I_{IB}

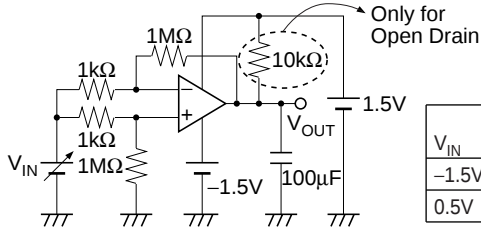


11. Power Supply Rejection Ratio, PSRR



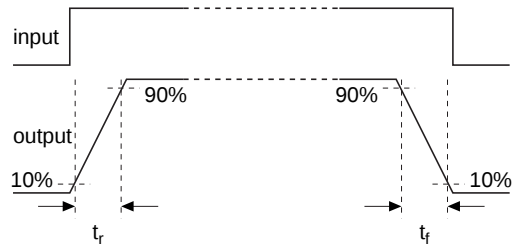
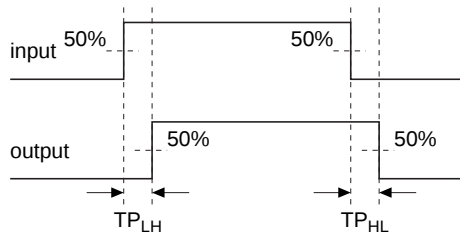
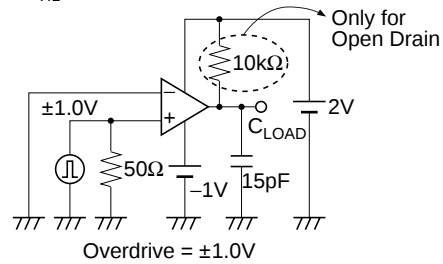
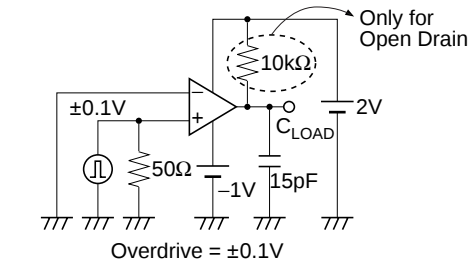
V_{DD}	Measure Point	Calculate V_{IO}	PSRR Calculation
-1.8V	V_{OUT1}	$V_{IO1} = V_{OUT1}/1000$	$PSRR = \left 20 \log_{10} \frac{ (V_{IO2} - V_{IO1}) }{5.5V - 1.8V} \right $
5.5V	V_{OUT2}	$V_{IO2} = V_{OUT2}/1000$	

12. Common Mode Rejection Ratio, CMRR

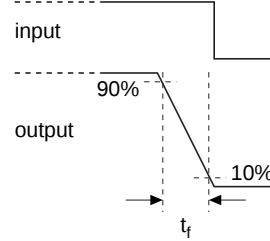
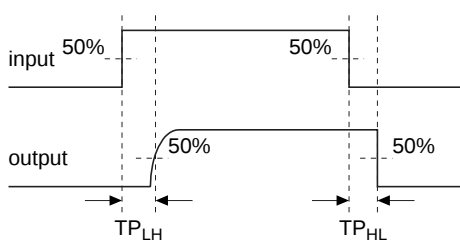


V_{IN}	Measure Point	Calculate V_{IO}	CMRR Calculation
-1.5V	V_{OUT1}	$V_{IO1} = V_{OUT1}/1000$	$CMRR = \left 20 \log_{10} \frac{ (V_{IO2} - V_{IO1}) }{0.5V - (-1.5V)} \right $
0.5V	V_{OUT2}	$V_{IO2} = V_{OUT2}/1000$	

13. Falling Time, Rising Time, Propagation Delay Time TP_{LH} , TP_{HL}



Only for Push Pull HA1631S01/02



Only for Open Drain HA1631S03/04

Main Characteristics

Figure 1-1 HA1631S01
Supply Current vs. Supply Voltage
(Output High)

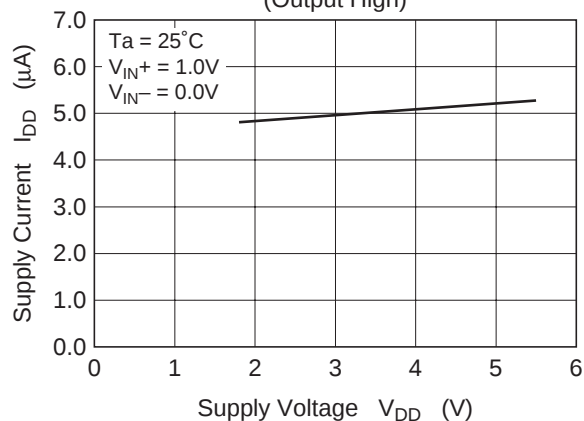


Figure 1-2 HA1631S01
Supply Current vs. Supply Voltage
(Output Low)

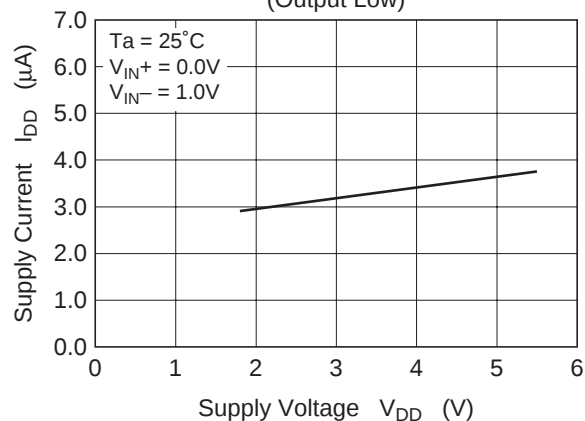


Figure 1-3 HA1631S01
Supply Current vs. Ambient Temperature

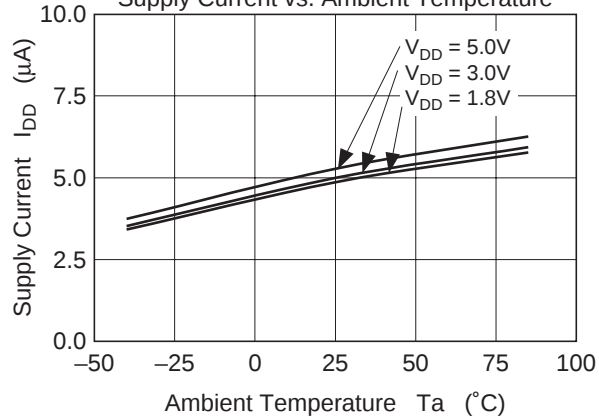


Figure 1-4 HA1631S01
Output High Voltage vs. Output Source Current

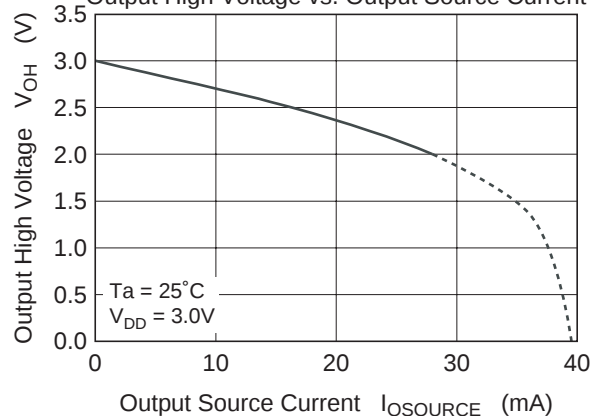


Figure 1-5 HA1631S01
Output Low Voltage vs. Output Sink Current

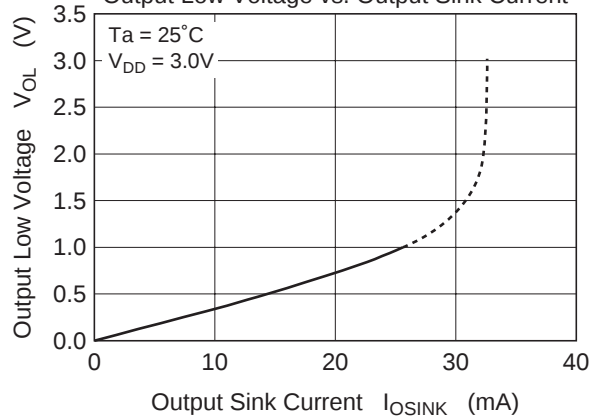
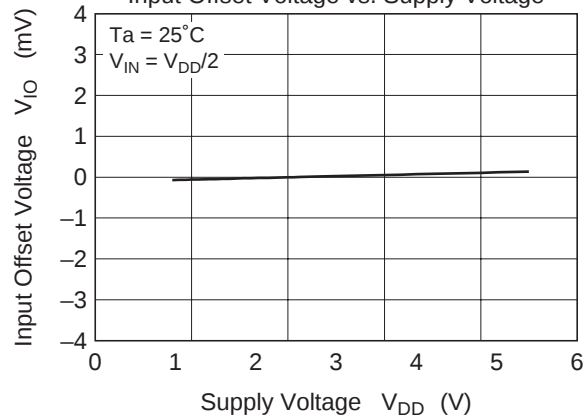
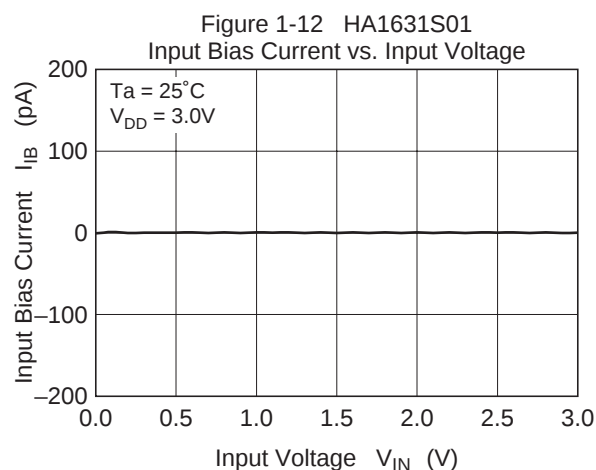
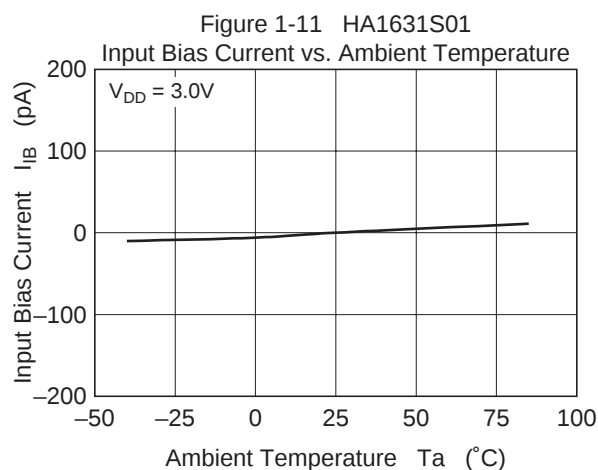
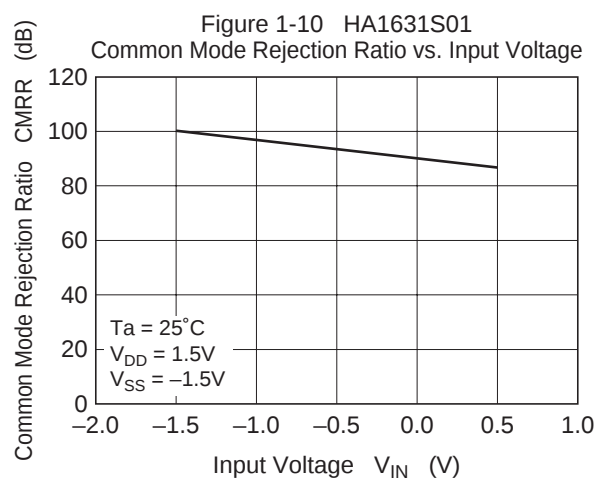
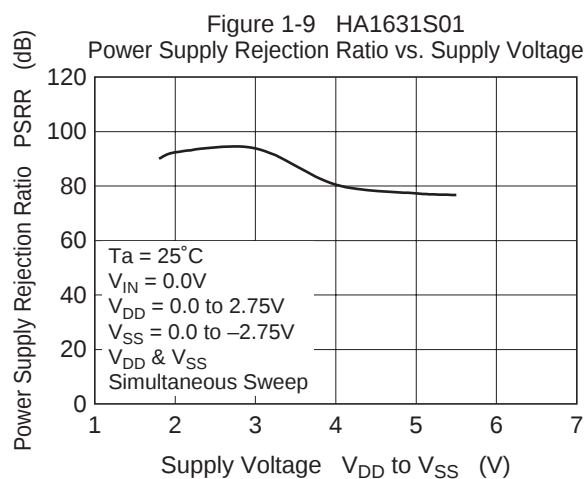
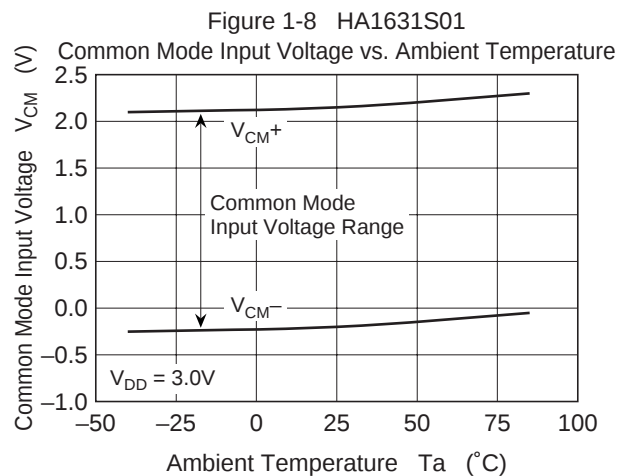
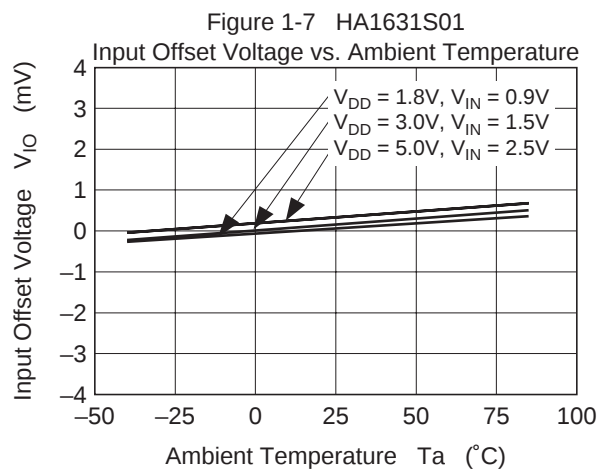


Figure 1-6 HA1631S01
Input Offset Voltage vs. Supply Voltage





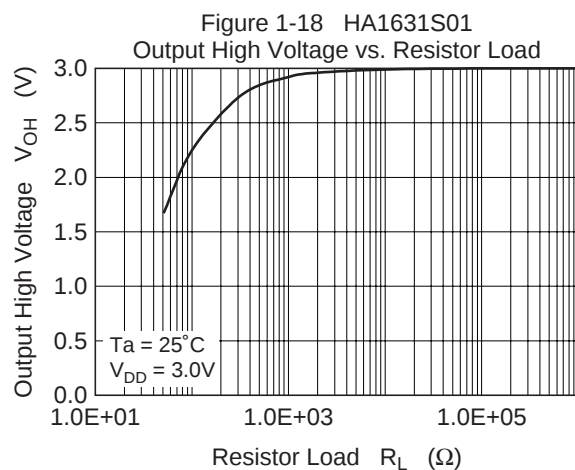
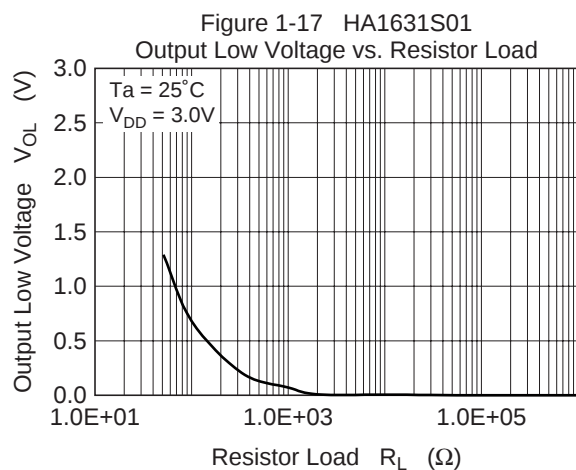
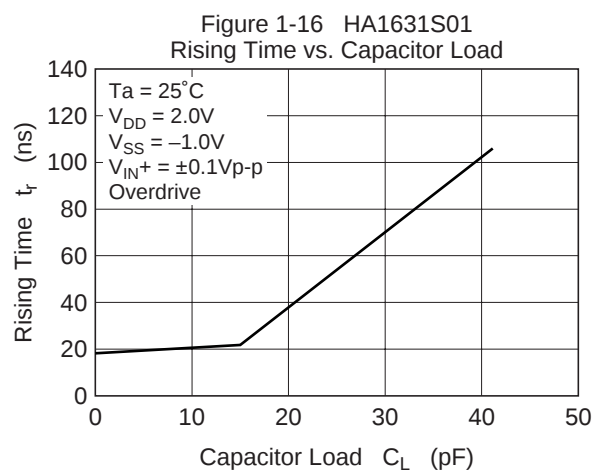
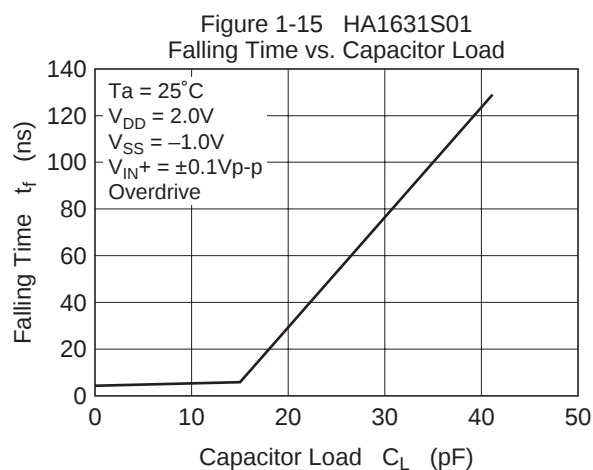
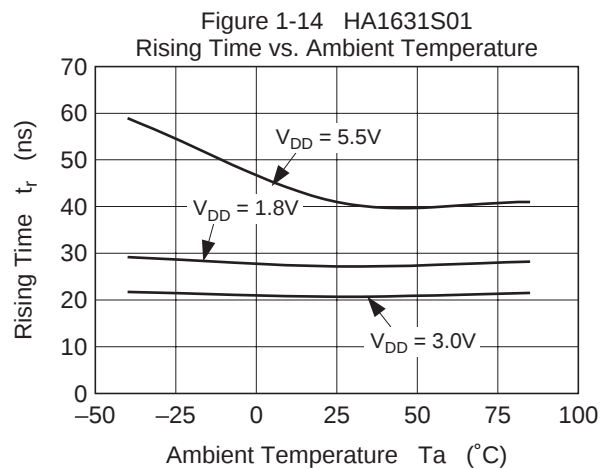
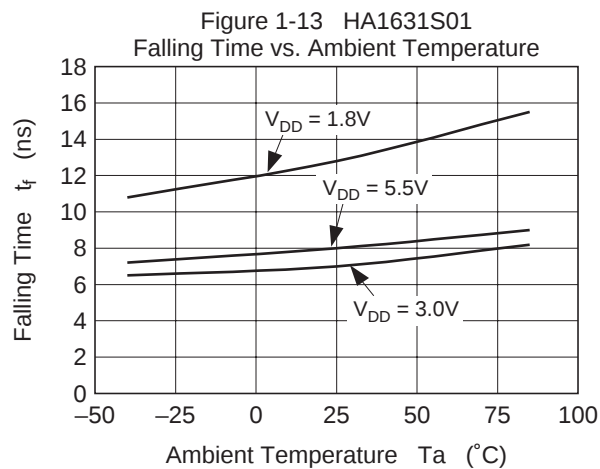


Figure 1-19 HA1631S01
Rising Time, t_r
(Overdrive = $\pm 0.1V_{p-p}$)

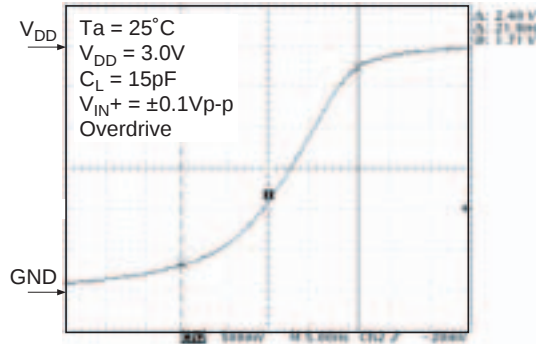


Figure 1-20 HA1631S01
Falling Time, t_f
(Overdrive = $\pm 0.1V_{p-p}$)

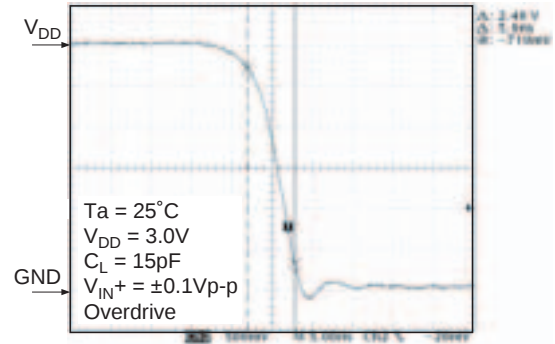


Figure 1-21 HA1631S01
 TP_{LH} Transient Response
(Overdrive = $\pm 0.1V_{p-p}$)

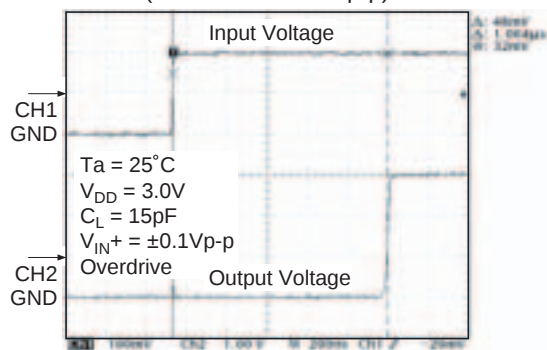


Figure 1-22 HA1631S01
 TP_{HL} Transient Response
(Overdrive = $\pm 0.1V_{p-p}$)

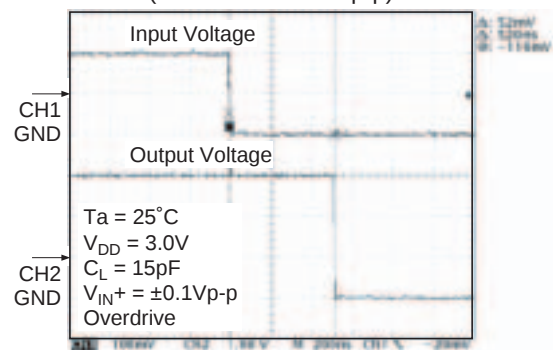


Figure 2-1 HA1631S02
Supply Current vs. Supply Voltage
(Output High)

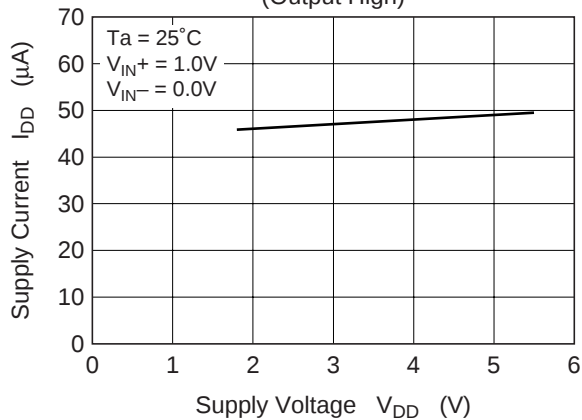


Figure 2-2 HA1631S02
Supply Current vs. Supply Voltage
(Output Low)

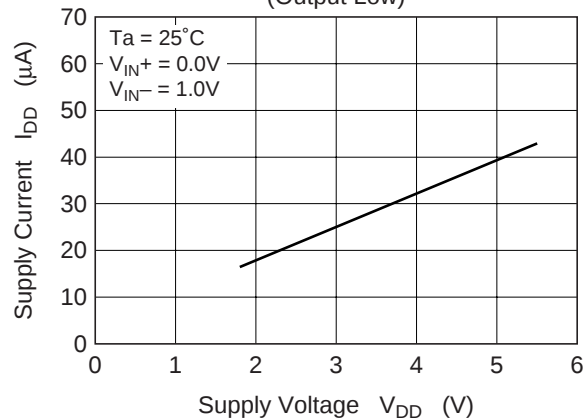


Figure 2-3 HA1631S02
Supply Current vs. Ambient Temperature

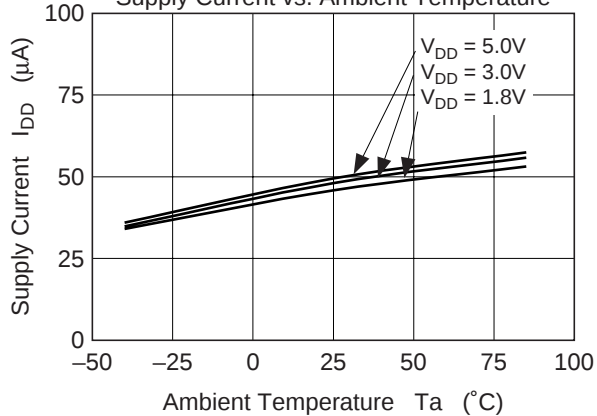


Figure 2-4 HA1631S02
Output High Voltage vs. Output Source Current

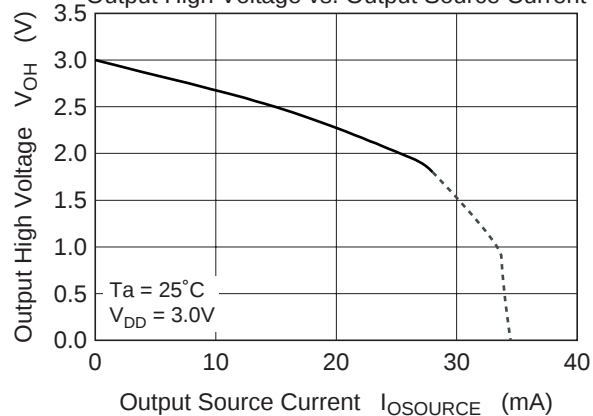


Figure 2-5 HA1631S02
Output Low Voltage vs. Output Sink Current

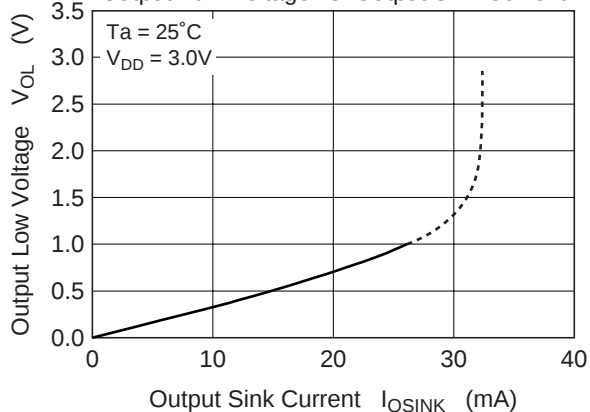


Figure 2-6 HA1631S02
Input Offset Voltage vs. Supply Voltage

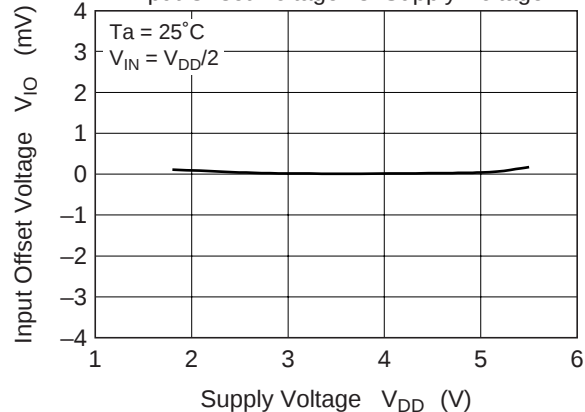


Figure 2-7 HA1631S02

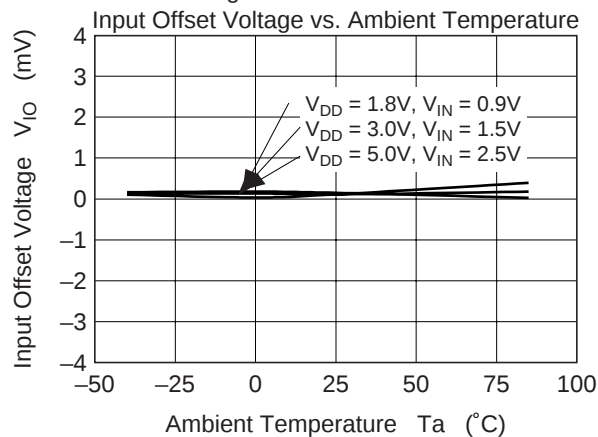


Figure 2-8 HA1631S02

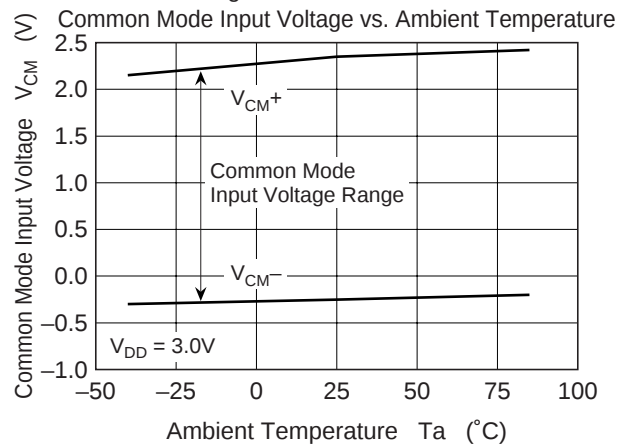


Figure 2-9 HA1631S02

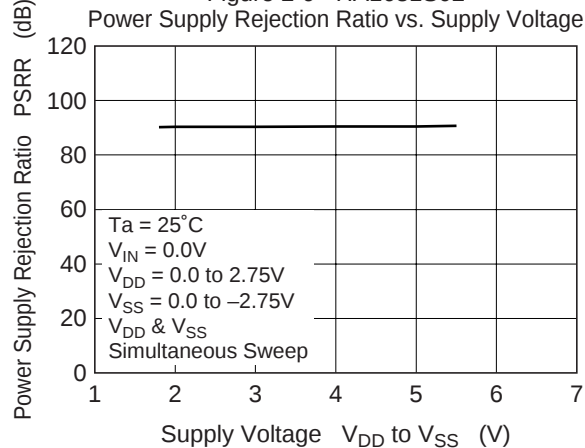


Figure 2-10 HA1631S02

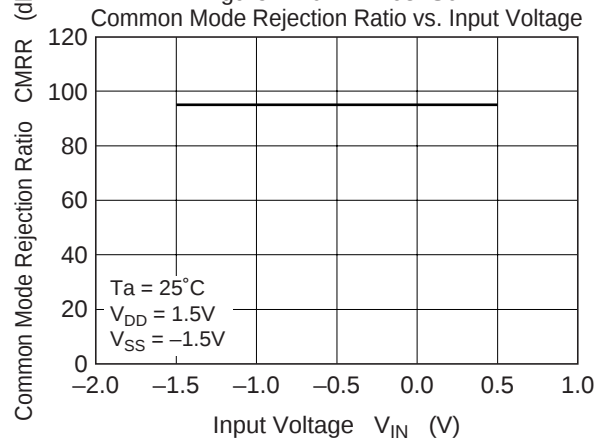


Figure 2-11 HA1631S02

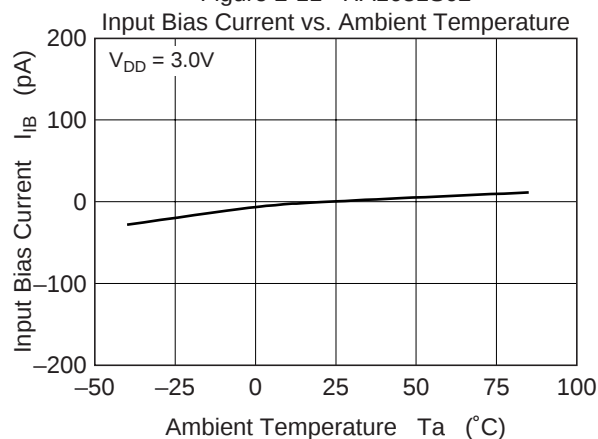
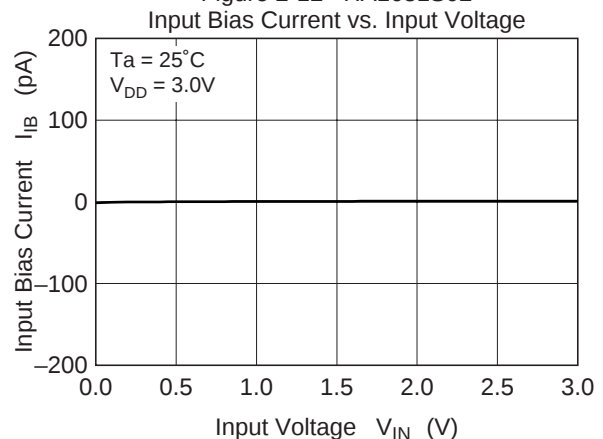


Figure 2-12 HA1631S02



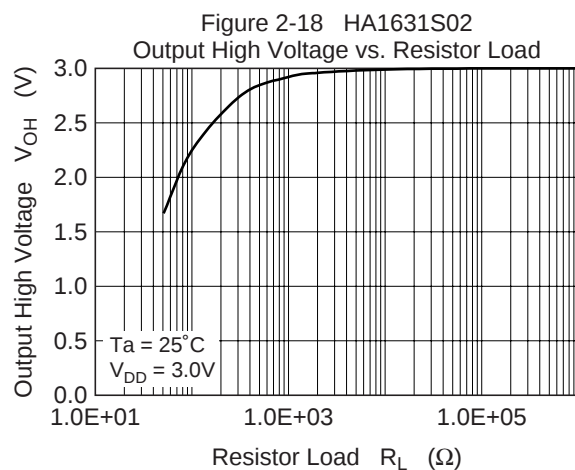
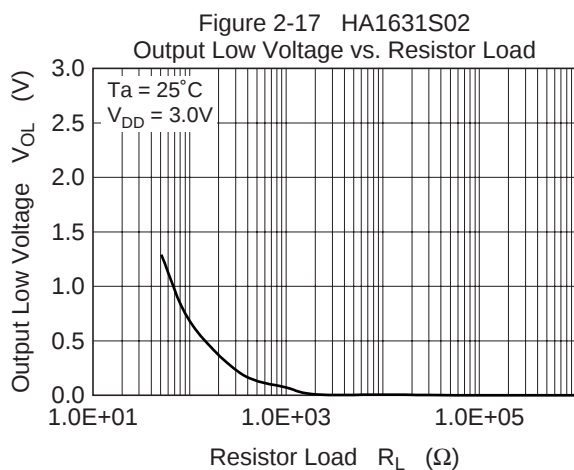
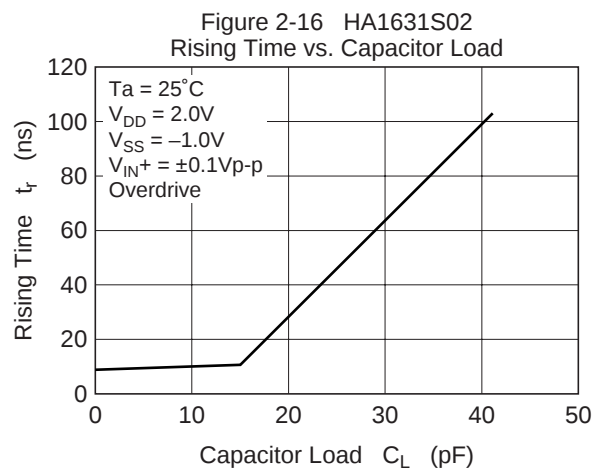
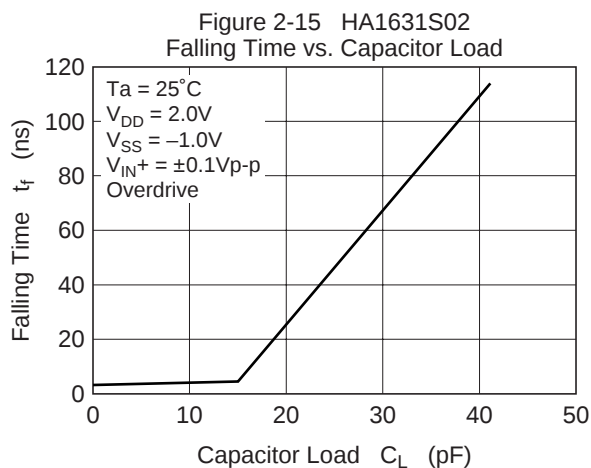
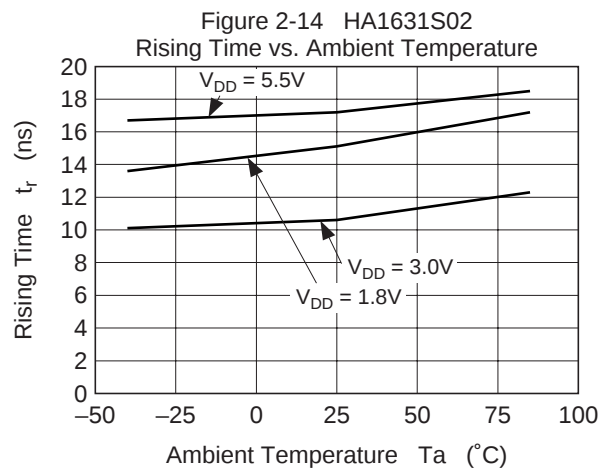
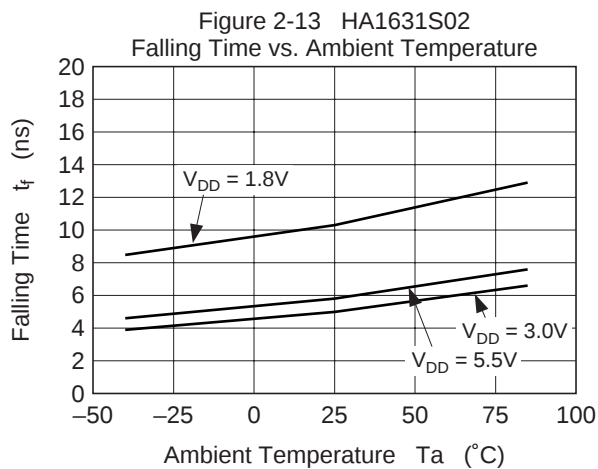


Figure 2-19 HA1631S02
Rising Time, t_r
(Overdrive = $\pm 0.1V_{p-p}$)

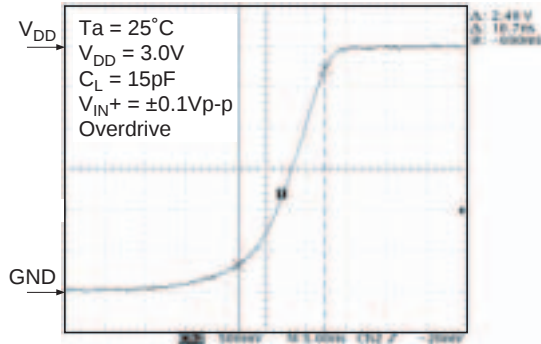


Figure 2-20 HA1631S02
Falling Time, t_f
(Overdrive = $\pm 0.1V_{p-p}$)

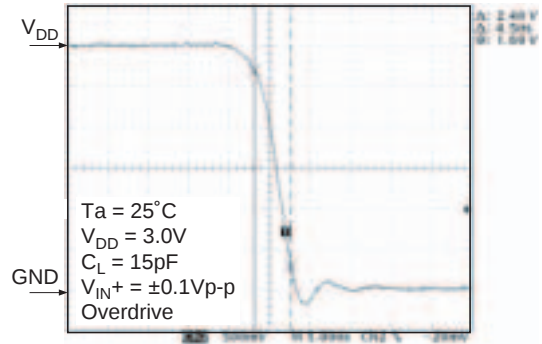


Figure 2-21 HA1631S02
 TP_{LH} Transient Response
(Overdrive = $\pm 0.1V_{p-p}$)

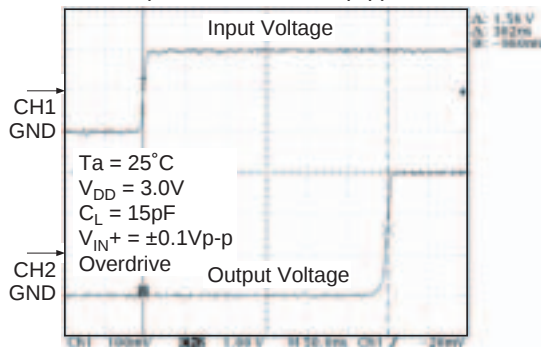


Figure 2-22 HA1631S02
 TP_{HL} Transient Response
(Overdrive = $\pm 0.1V_{p-p}$)

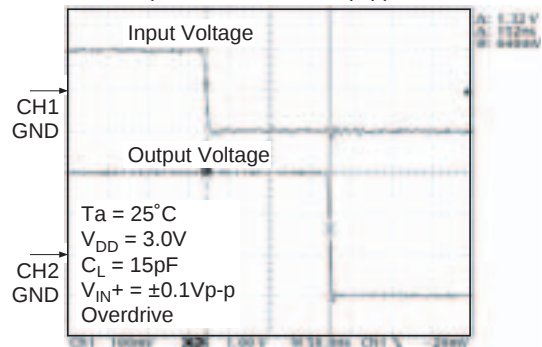


Figure 3-1 HA1631S03
Supply Current vs. Supply Voltage
(Output High)

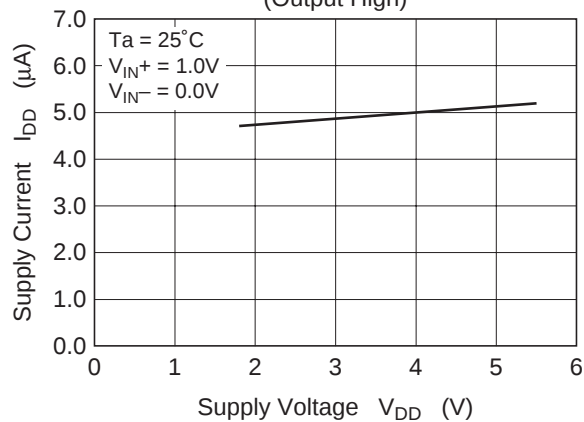


Figure 3-2 HA1631S03
Supply Current vs. Supply Voltage
(Output Low)

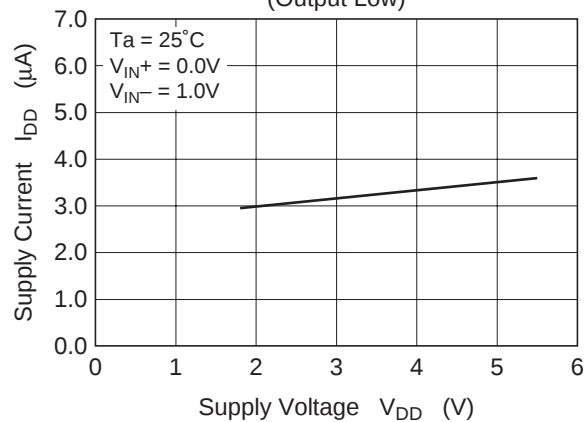


Figure 3-3 HA1631S03
Supply Current vs. Ambient Temperature

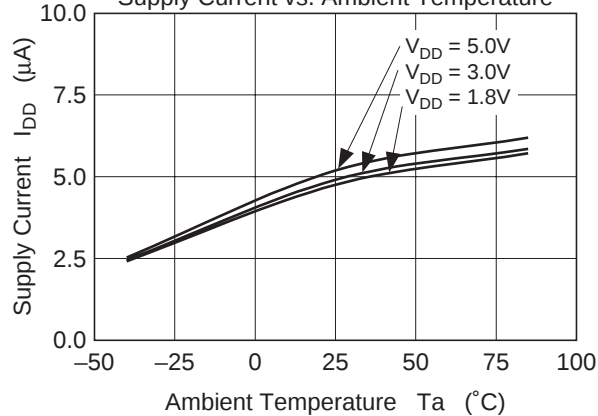


Figure 3-4 HA1631S03
Output Low Voltage vs. Output Sink Current

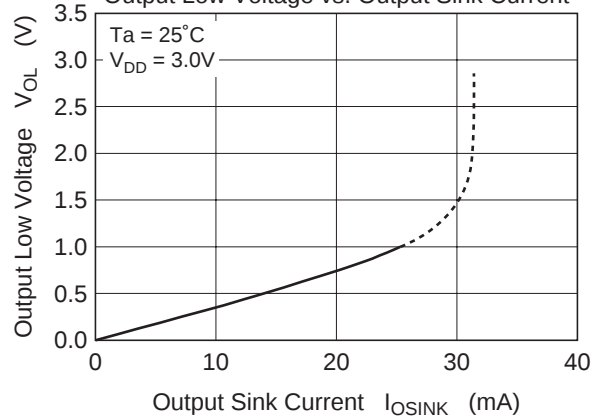


Figure 3-5 HA1631S03
Input Offset Voltage vs. Supply Voltage

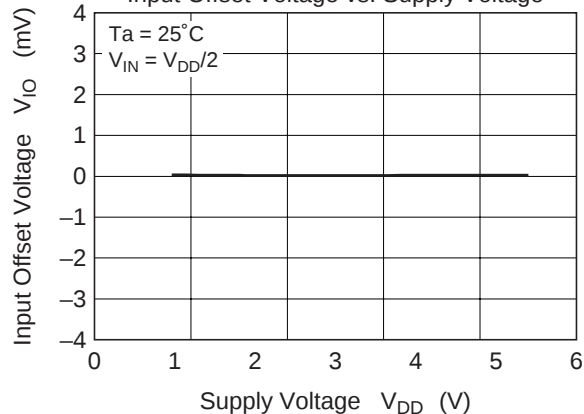


Figure 3-6 HA1631S03
Input Offset Voltage vs. Ambient Temperature

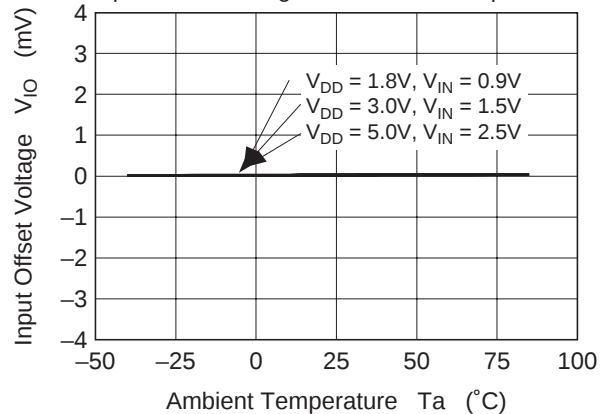


Figure 3-7 HA1631S03

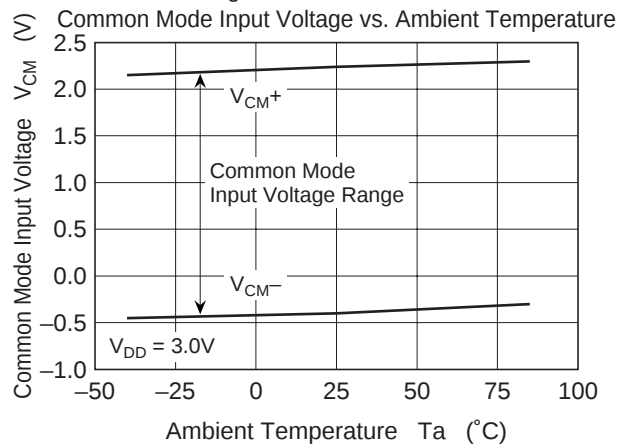


Figure 3-8 HA1631S03

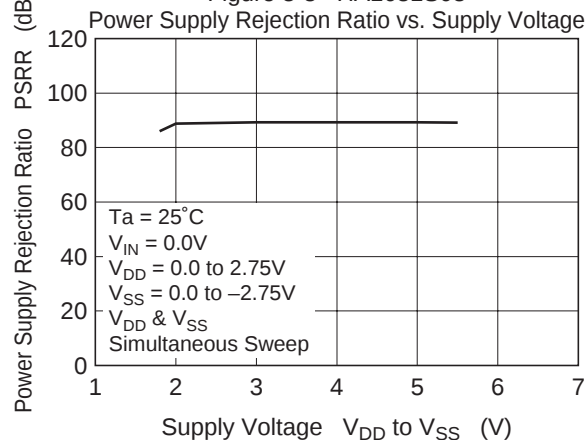


Figure 3-9 HA1631S03

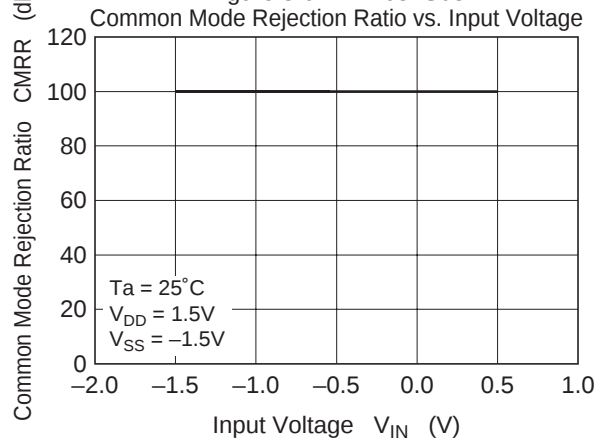


Figure 3-10 HA1631S03

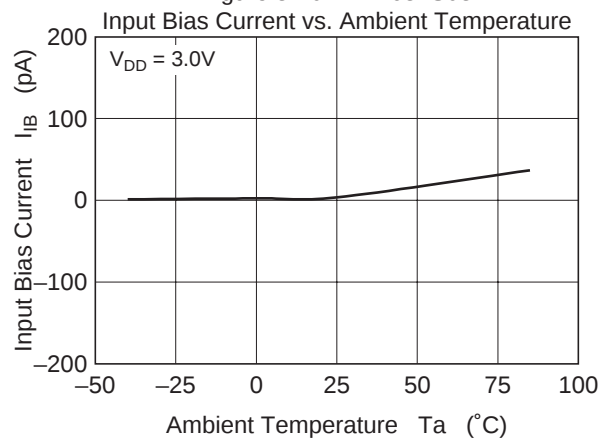


Figure 3-11 HA1631S03

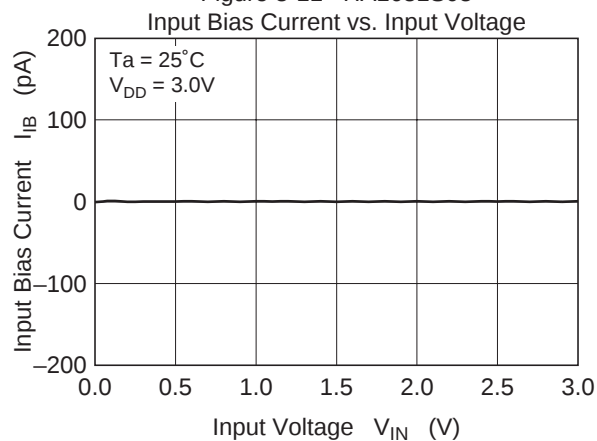


Figure 3-12 HA1631S03

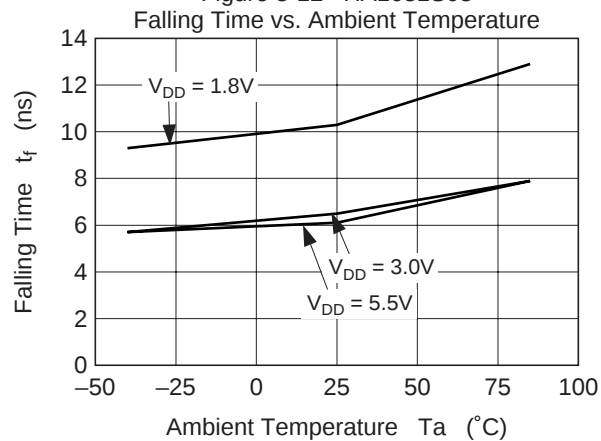


Figure 3-13 HA1631S03
Falling Time vs. Capacitor Load

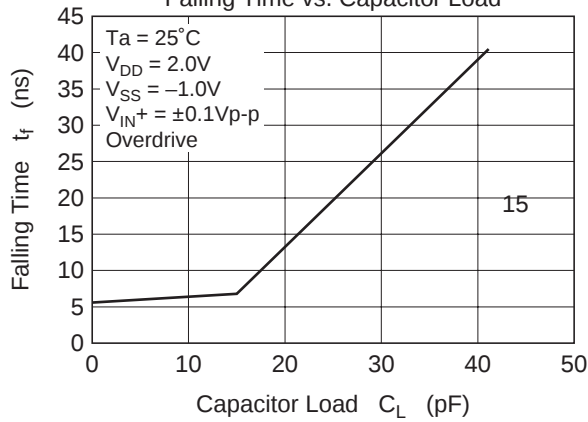


Figure 3-14 HA1631S03
Output Low Voltage vs. Resistor Load

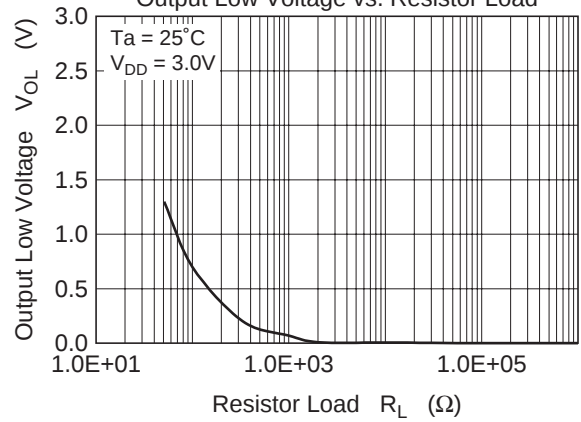


Figure 3-15 HA1631S03
Falling Time, t_f

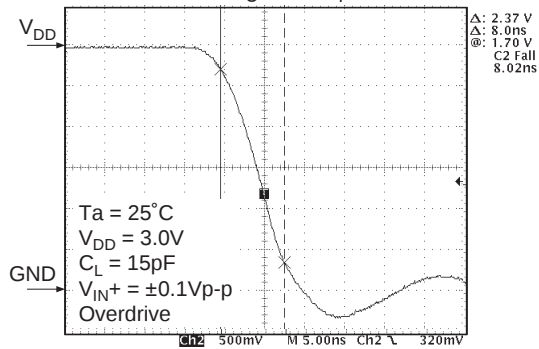


Figure 3-16 HA1631S03
 TP_{HL} Transient Response
(Overdrive = $\pm 0.1\text{Vp-p}$)

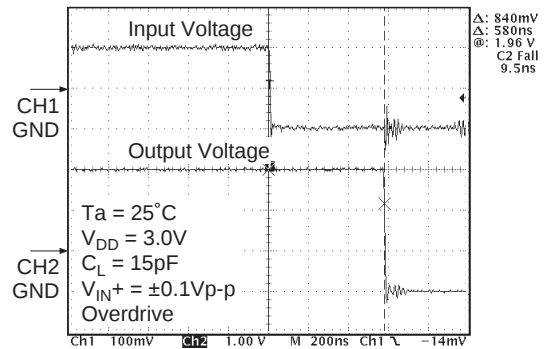


Figure 3-17 HA1631S03
 TP_{HL} Transient Response
(Overdrive = $\pm 0.1\text{Vp-p}$)

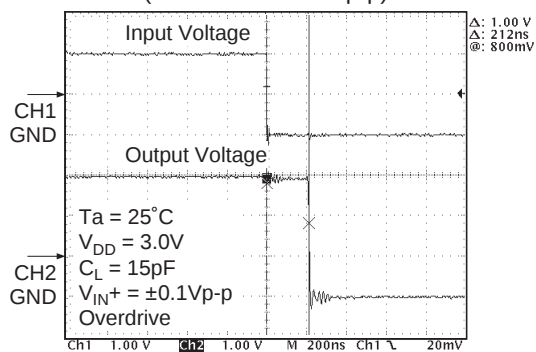


Figure 4-1 HA1631S04
Supply Current vs. Supply Voltage
(Output High)

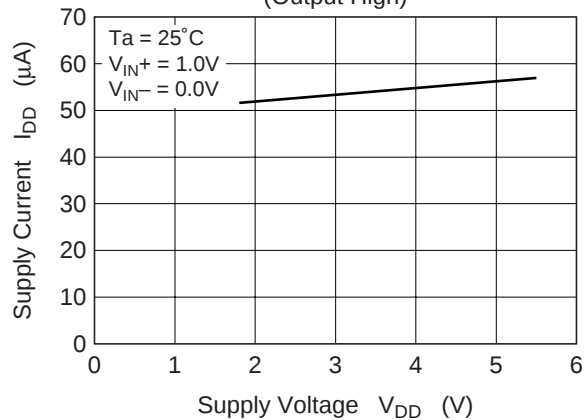


Figure 4-2 HA1631S04
Supply Current vs. Supply Voltage
(Output Low)

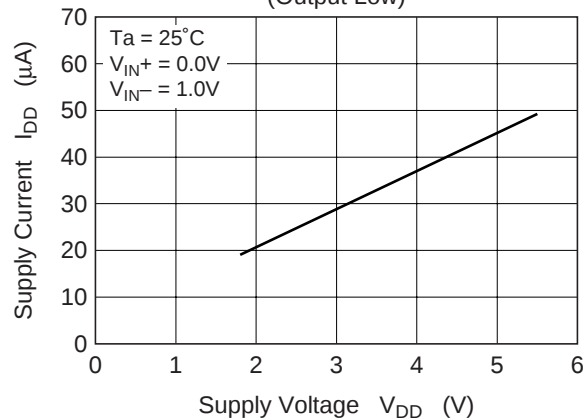


Figure 4-3 HA1631S04
Supply Current vs. Ambient Temperature

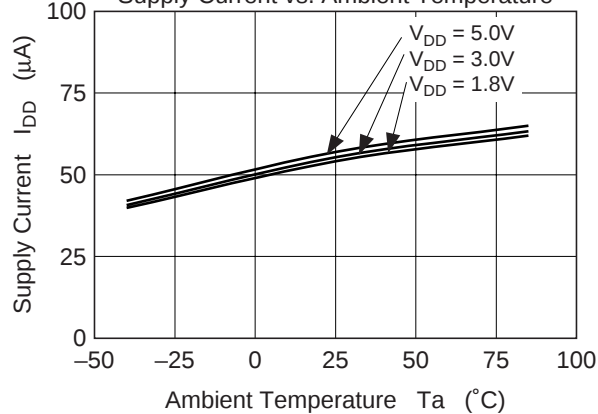


Figure 4-4 HA1631S04
Output Low Voltage vs. Output Sink Current

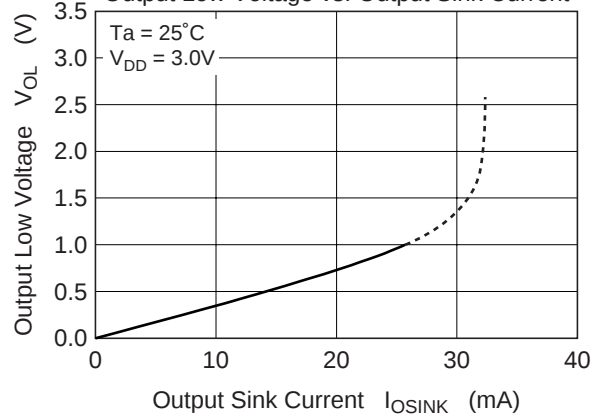


Figure 4-5 HA1631S04
Input Offset Voltage vs. Supply Voltage

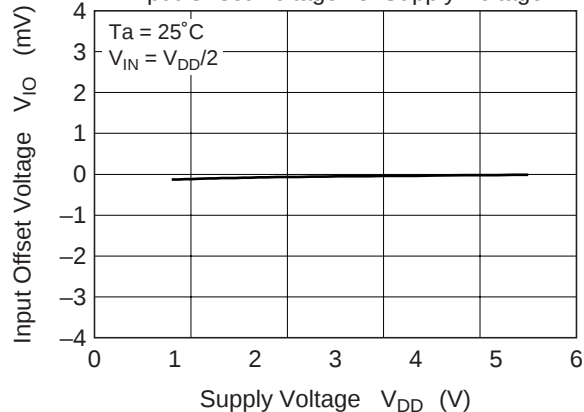


Figure 4-6 HA1631S04
Input Offset Voltage vs. Ambient Temperature

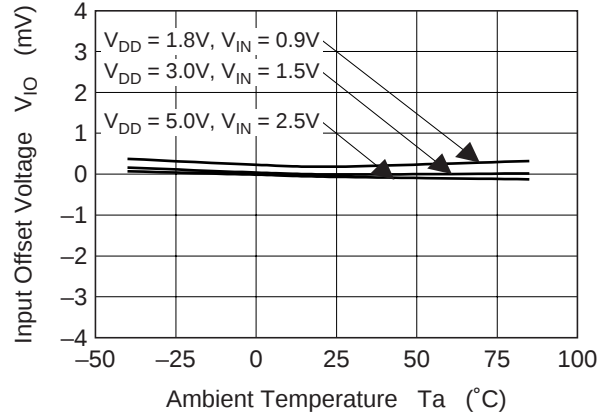


Figure 4-7 HA1631S04

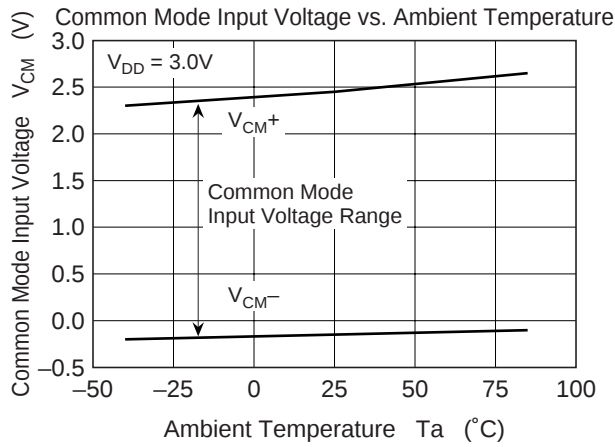


Figure 4-8 HA1631S04

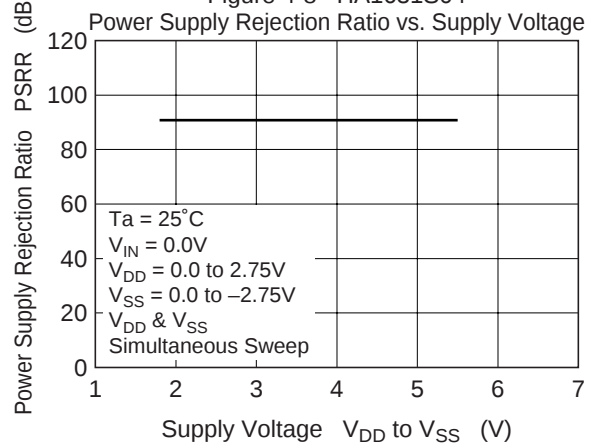


Figure 4-9 HA1631S04

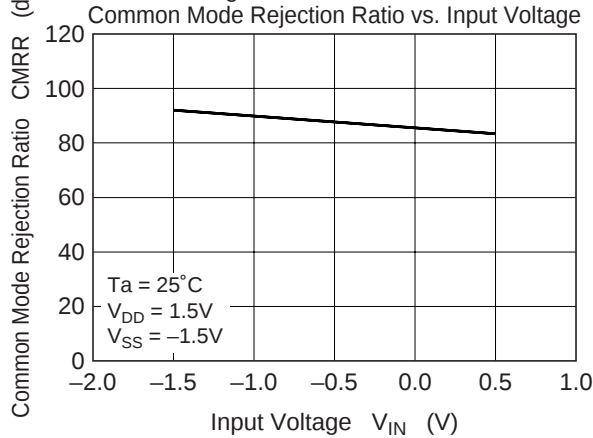


Figure 4-10 HA1631S04

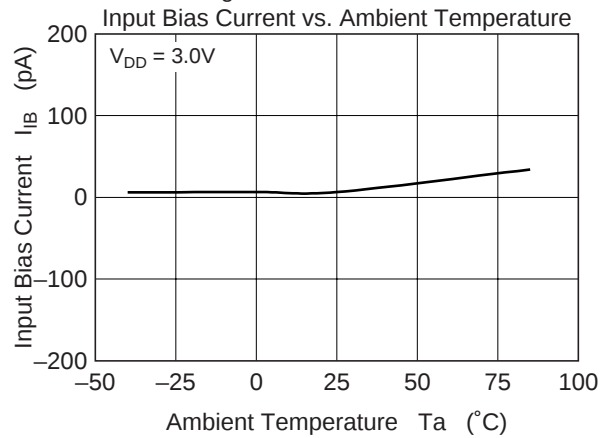


Figure 4-11 HA1631S04

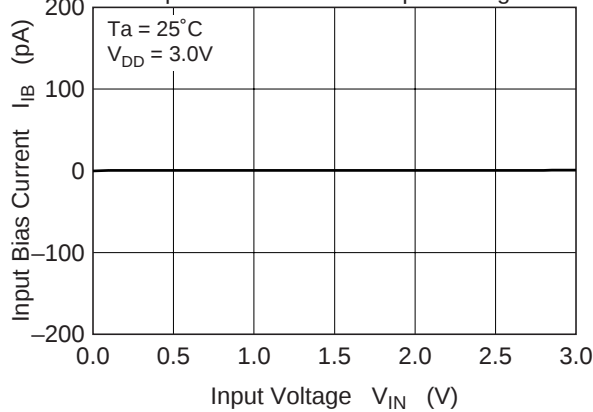
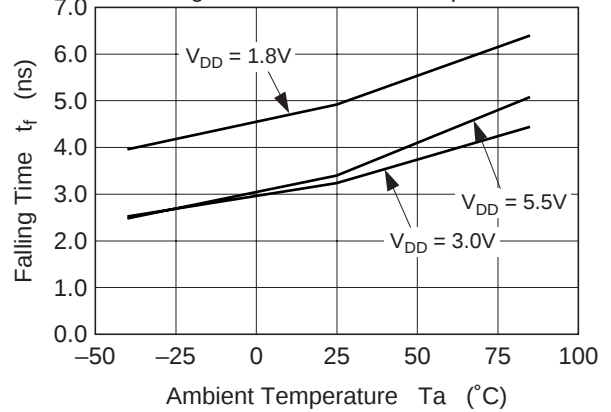
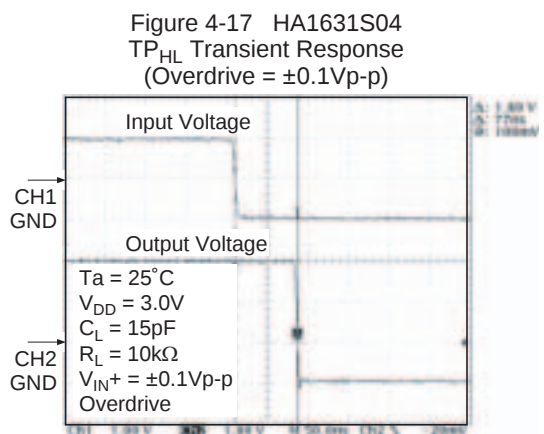
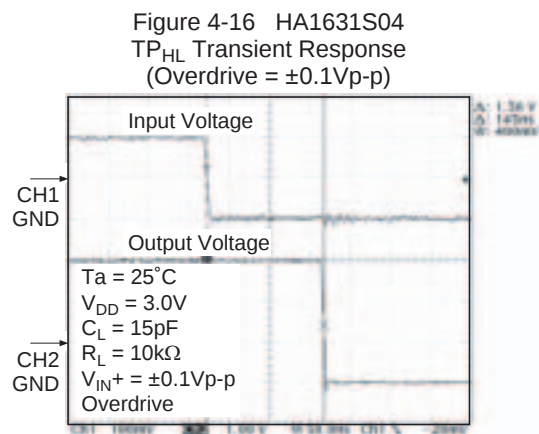
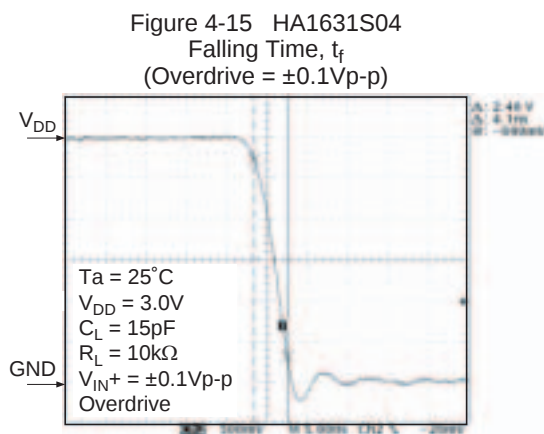
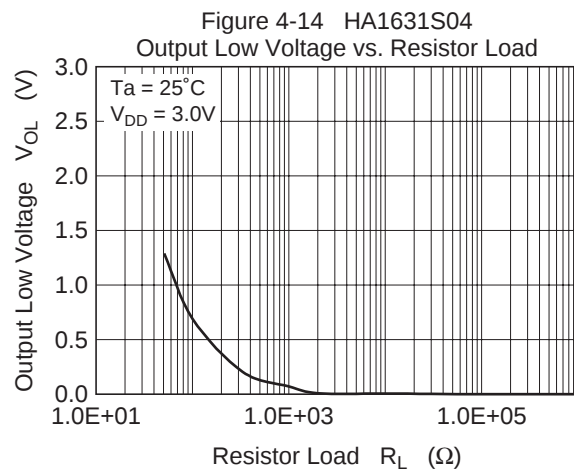
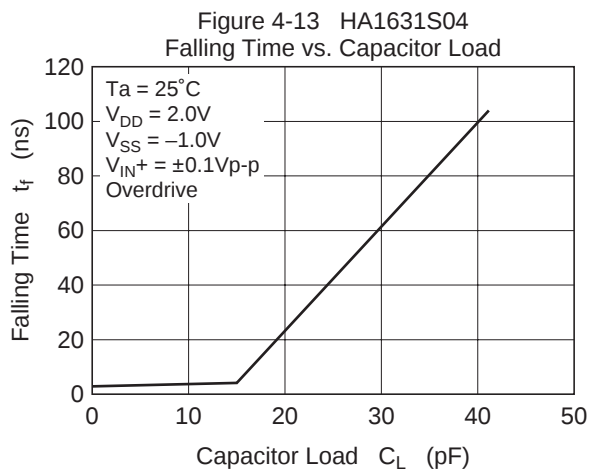
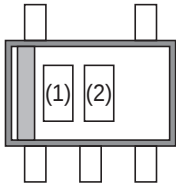


Figure 4-12 HA1631S04



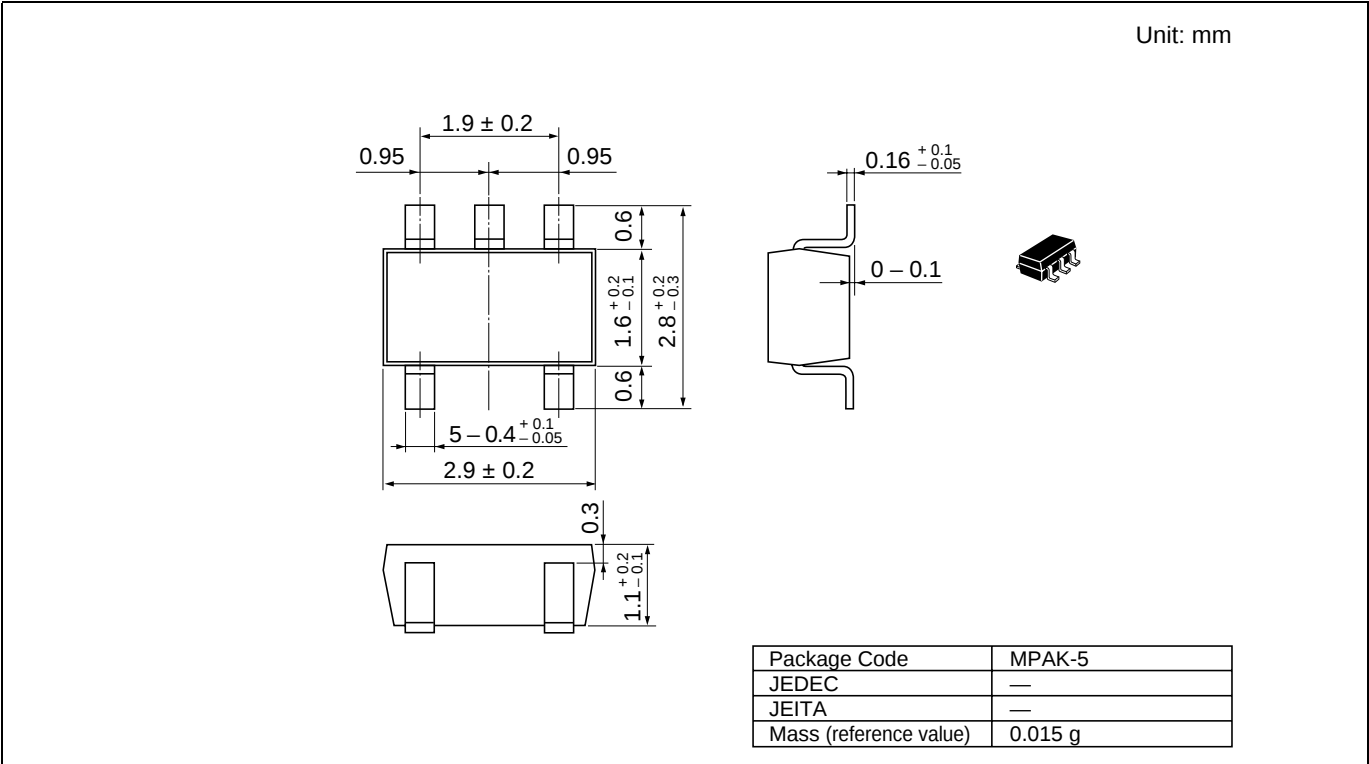
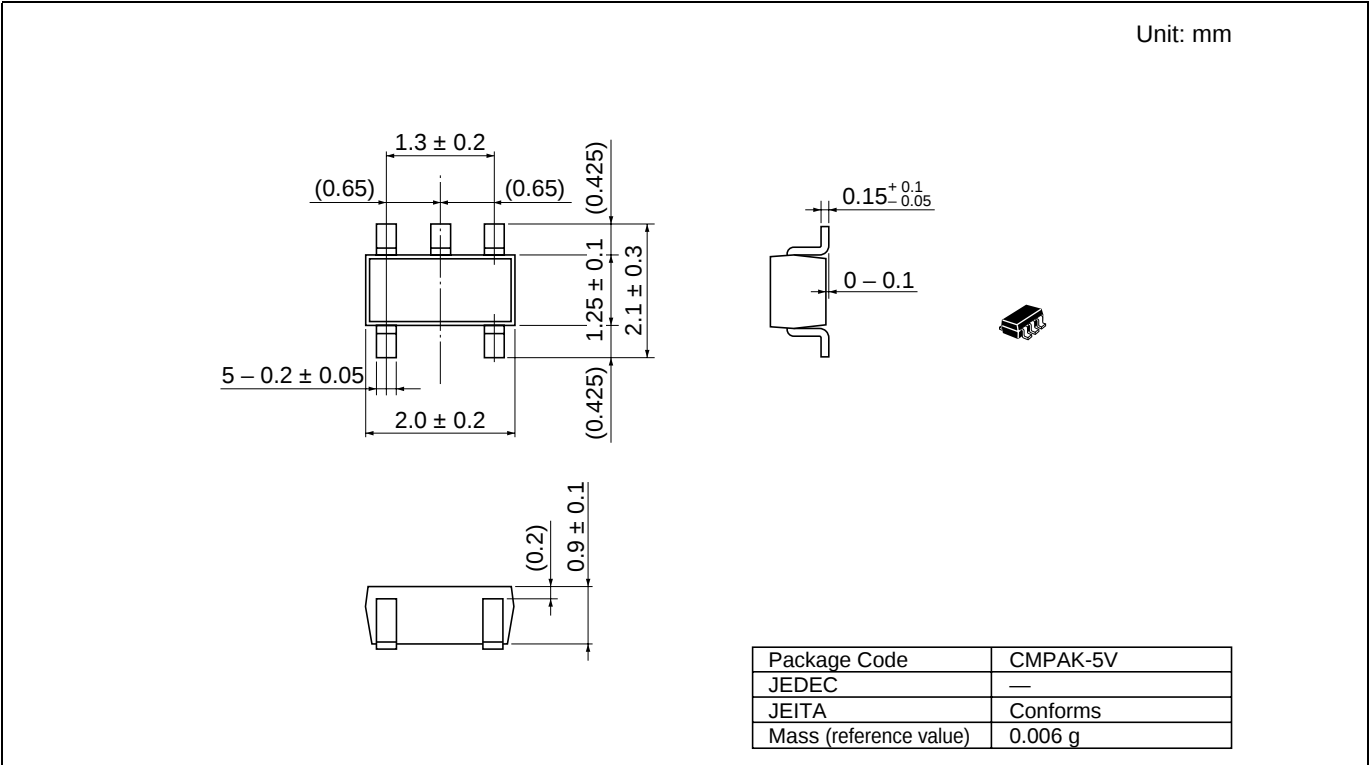


Mark Indication



		(1)	(2)
HA1631S01CM	HA1631S01LP	0	A
HA1631S02CM	HA1631S01LP	0	B
HA1631S03CM	HA1631S01LP	0	C
HA1631S04CM	HA1631S01LP	0	D

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